

Information & Control Taiwan TC Chapter Meeting Summary and Minutes

Taiwan Standards Meeting 2023

Friday, May 5, 2023, Begin 08:30 a.m. – End 10:00 a.m. [Taiwan]
Official Virtual TC Chapter Meeting[Hybrid]

TC Chapter Announcements

Next TC Chapter Meeting

Friday, August 18, 2023

SEMI Taiwan office, Hsinchu County, Taiwan [Hybrid]

Table 1 Meeting Attendees

Italics indicate virtual participants

Co-Chairs: Scott Yu (TSMC)

SEMI Staff: Cher Wu, Ada Tai, Monica Hung

Company	First Name	Last Name	Company	First Name	Last Name
FIL Technology	Jack	Huang	Eunodata	Kun-Yung	Wang
Changing Information	Miller	Chang	Eunodata	Stephen	Liu
Cimetrix	Michael	Lee	ITRI	Ares	Cho
Delta	Anderson	Ni	Nanya	Shadow	Shen
Delta	WC	Tian	Peer Group Inc.	Albert	Fuchigami
Docutek Solutions,	Lamber	Lin	PSMC	Tim	Chen
Egis Technology	Karen	Chang			

Table 2 Leadership Changes

WG/TF/SC/TC Name	Previous Leader	New Leader
None		

Table 3 Committee Structure Changes

Previous WG/TF/SC Name	New WG/TF/SC Name or Status Change
None	

Table 4 Ballot Results

Document #	Document Title	Committee Action
None		

^{#1} Passed ballots and line items will be submitted to the ISC Audit & Review Subcommittee for procedural review.

^{#2} Failed ballots and line items were returned to the originating task forces for re-work and re-balloting or abandoning.



Table 5 Activities Approved by the GCS between meetings of the TC Chapter

#	Туре	SC/TF/WG	Details
None			

Table 6 Authorized Activities

Listing of all revised or new SNARF(s) approved by the Originating TC Chapter.

#	Туре	SC/TF/WG	Details
TBD			Line item revision for SEMI E187(0122)- Specification for Cybersecurity of Fab Equipment

^{#1} SNARFs and TFOFs are available for review on the SEMI Web site at:

 $\underline{http://downloads.semi.org/web/wstdsbal.nsf/TFOFSNARF}$

Table 7 Authorized Ballots

#	<u>ı</u>	When	TF	Details
#693	-	2023	Equipment Edge Data Governance (EEDG)	New Standard: Guide for Equipment Edge Data Governance (EEDG)

Table 8 SNARF(s) Granted a One-Year Extension

#	TF	Title	Expiration Date
None			

Table 9 SNARF(s) Abolished

#	Т	TF .	Title
None			

Table 10 Standard(s) to receive Inactive Status

	Standard Designation	Title
N	one	

Table 11 New Action Items

Item #	Assigned to	Details	
None			

Table 12 Previous Meeting Action Items

Item #	Assigned to	Details
None		

1. Welcome, Reminders, and Introductions



Scott Yu (TSMC) called the meeting to order at 08:30. The meeting reminders on antitrust issues, intellectual property issues and holding meetings with international attendance were reviewed. Attendees introduced themselves.

Attachment: Required Element Nov 2020

2. Review of Previous Meeting Minutes

The TC Chapter reviewed the minutes of the previous meeting.

Motion:	Approve the Minutes as written.
By / 2 nd :	Tim Cheng (PSMC)/ Kun-Yung Wang (Eunodata)
Discussion:	None
Vote:	13-Y 0-N in favor. Motion passed

Attachment: <u>I&C Taiwan TC Meeting Minutes_20221130_v1</u>

3. Liaison Reports

3.1. Information & Control North America TC Chapter

Cher Wu(SEMI) reported for the I&C NA TC Chapter

Attachment: NA I&C Liaison Report 2023-4

3.2 Information & Control Japan TC Chapter

Cher Wu(SEMI) reported for the I&C Japan TC Chapter

Attachment: JA I&C Liaison 20230419 v1.1

3.3 Information & Control Korea TC Chapter

Cher Wu reported for the I&C Korea TC Chapter

Attachment: Liaison report InC KR Mar2023

3.4 Information & Control China TC Chapter

Cher Wu reported for the I&C China TC Chapter

Attachment: China I&C Committee Chapter Liaison Report -v1

4. SEMI Staff Report

--Cher Wu (SEMI) gave the SEMI Staff Report

SEMI Global 2023 Calendar of SEMICON and other Events.

2023 Critical Dates for SEMI Standards Ballots

Attachment: <u>I&C TC Staff Report 20230505</u>

5. Ballot Review

None



6. Subcommittee and Task Force Reports

- 6.1 GEM300 Task Force: None
- 6.2 Equipment Information Integration Task Force: None
- 6.3 Backend Factory Integration TF: None
- 6.4 Fab and Equipment Information Security TF:
 - ◆ Co-TF Leader Ares Cho(ITRI) reported for the SEMI E187 actives of New SNARF
 - ◆ Proposal to Submit the New SNARF for Line Item Revision of SEMI E187(0122)- Specification for Cybersecurity of Fab Equipment
- 6.5 Equipment Edge Computing Data Governance TF
 - ◆ TF leader KY Wang(Eunodata) and Stephen Liu(Eunodata) reported for the EEDG TF.
 - ♦ EEDG TF reviewed the #6938 in the TF meeting and decided to submit to Taiwan TC for approval.

7. Old Business

None

8. New Business

8.1. Proposal of New Activity

Authorize the Document #6938 new Standards: Guide for Equipment Edge Data Governance (EEDG) for cycle5-2023 Letter Ballot

Motion:	Authorize the Document # 6938 for Cycle5-2023 Letter Ballot	
By / 2 nd	Tim Chen (PSMC)/ Shadow Shen (Nanya)	
Discussion:	None	
Vote:	12-Y 0-N. Motion passed.	

New SNARF Proposal for SEMI E187(0122)- Specification for Cybersecurity of Fab Equipment.

Motion:	Approve the SNARF for Line Item Revision to New SNARF for SEMI E187(0122)- Specification for Cybersecurity of Fab Equipment
By / 2 nd	Miller Chang (Changing Information Technology Inc.)/ Tim Chen (PSMC)
Discussion:	None
Vote:	12-Y 0-N. Motion passed.

9. Next Meeting and Adjournment

The next meeting is on August 18,2023 at SEMI Taiwan office(Hybrid). See http://www.semi.org/standards-events for the current list of events.

Adjournment: 09:54



Respectfully submitted by:

Cher Wu

Senior Executive Consultant

SEMI Taiwan

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Minutes tentatively approved by:

Chair	Date approved
Scott Yu/ TSMC	2023/5/19 approved

Table 13 Index of Available Attachments#1

Title	Title
01_Required Element Nov 2020	05_Liaison report_InC_KR Mar2023
02_I&C Taiwan TC Meeting Minutes 20221130 v1	06_China I&C Committee Chapter Liaison Report -v1
03_ NA I&C Liaison Report 2023-4	07_I&C TC Staff Report 20230505
04_ JA_I&C_Liaison_20230419_v1.1	

^{#1} Due to file size and delivery issues, attachments must be downloaded separately. A .zip file containing all attachments for these minutes is available at www.semi.org. For additional information or to obtain individual attachments, please contact [SEMI Staff Name] at the contact information above.